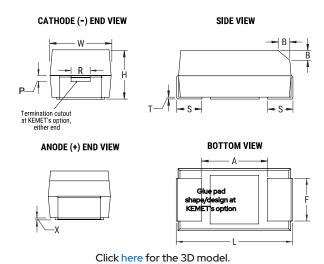


T598D157M006AHE045

T598, Tantalum, Polymer Tantalum, Commercial Grade, 150 uF, 20%, 6.3 VDC, SMD, Polymer, Molded, Low ESR, AEC-Q200, 45 mOhms, 7343, 3.1 mm, 1.3 mm



General Information	
Series	T598
Dielectric	Polymer Tantalum
Style	SMD Chip
Description	SMD, Polymer, Molded, Low ESR, AEC-Q200
Features	Automotive
RoHS	No
Prop 65	WARNING: Cancer and reproductive harm - https://www.p65warnings.ca.gov /
SCIP Number	b064b03e-bd75-42af-b342-1fe 94dec2340
Termination	Tin Lead (SnPb)
Qualifications	AEC-Q200
AEC-Q200	Yes
Typical Component Weight	434.8 mg
Shelf Life	52 Weeks
MSL	3

150 uF

20%

(125C)

-55/+125°C 105°C

6.3 VDC (105C), 4.22 VDC

85C, 85% RH, load, 1000 Hours

Dimensions	
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
Н	2.8mm +/-0.3mm
T	0.13mm REF
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
A	3.8mm MIN
В	0.5mm +/-0.15mm
P	0.9mm REF
R	1mm REF
X	0.1mm +/-0.1mm REF

500

Packaging Quantity

Packaging	T&R, 178mm		
Packaging Specifications		Leakage Current	94.5 uA (5min 25°C)
x	0.1mm +/-0.1mm REF	Ripple Current	3160 mA (rms, 100kHz 45C), 2212 mA (rms, 105C), 790 mA (rms, 125C)
R	0.5mm +/-0.15mm 0.9mm REF	ESR	45 mOhms (100kHz 25C)
P		Failure Rate	N/A
В		Dissipation Factor	10% 120Hz 25C

Specifications
Capacitance

Tolerance

Humidity

Voltage DC

Temperature Range

Rated Temperature

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

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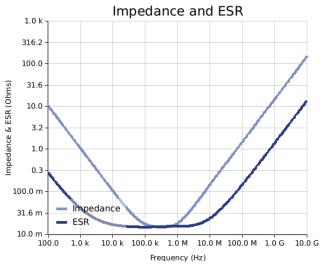


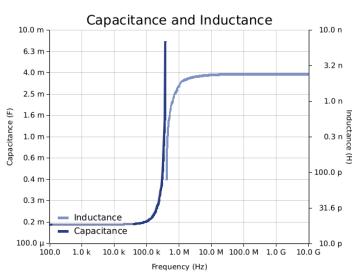
T598D157M006AHE045

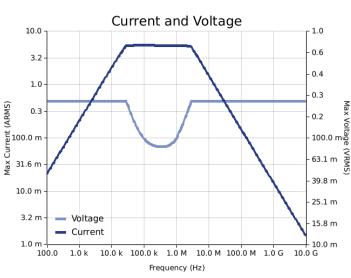
T598, Tantalum, Polymer Tantalum, Commercial Grade, 150 uF, 20%, 6.3 VDC, SMD, Polymer, Molded, Low ESR, AEC-Q200, 45 mOhms, 7343, 3.1 mm, 1.3 mm

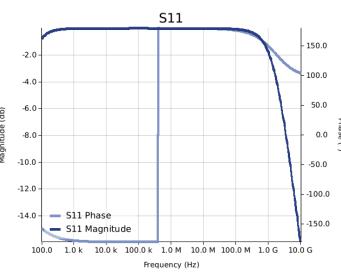
Simulations

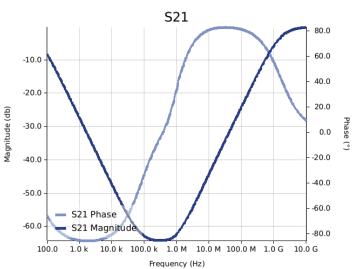
For the complete simulation environment please visit Y-SIM.











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T598D157M006AHE045

T598, Tantalum, Polymer Tantalum, Commercial Grade, 150 uF, 20%, 6.3 VDC, SMD, Polymer, Molded, Low ESR, AEC-Q200, 45 mOhms, 7343, 3.1 mm, 1.3 mm

These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.

- The ESR in the "Temperature Rise vs. Ripple Current" plots is the ESR at ambient temperature. The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated. The effects shown herein are based on measured data from a multiple part sample of the parts in question. Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

 The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages
- generated at any other harmonics.

 Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

All Information given herein is believed to be accurate and reliable, but is presented without guarantee, warranty, or responsibility of any kind, expressed or implied. Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute – and we specifically disclaim – any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

If you have any questions please contact K-SIM.

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